

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Srinivasan Chakravarthi, et al.

Art Unit: 2813

Division of Serial No.: 10/020,813

Examiner: Yennhu B. Huynh

Filed: Herewith

Docket: TI-33161.1

For: Fabrication of Ultra Shallow Junctions from a Solid Source with Fluorine Implantation

"EXPRESS MAILING" Mailing Label No. EV334469431US. I hereby certify that this paper is being deposited with the U.S. Postal Service Express Mail Post Office to Addressee Service under 37 CFR 1.10 on the date shown below and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Karen Vertz  
Karen Vertz

10-2-03  
Date

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Dear Sir:

Prior to the examination of the above-identified application, please amend as follows:

**IN THE SPECIFICATION:**

Please amend the Specification by inserting before the first line the following sentence:

--This is a division of Application No. 10/020,813, filed 12/12/2001, the entire disclosure of which is hereby incorporated herein by reference--.